Particle Detection: Trackers

Lecture 2

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Outline

Lecture 1

- 1. Interaction of charged particle with matter
- 2. Momentum measurement
- 3. Drift and Diffusion in Gases
- 4. History of Tracking Detectors
- 5. Proportional Chambers

Lecture 2

- 6. Drift Chambers
- 7. Micro Pattern Gas Chambers
- 8. Limitations of Gaseous Detectors

Lecture 3

- 9. Vertex Reconstruction
- 10. Semiconductor Detectors
- 11. Silicon Strip and Pixel Detectors
- 12. Radiation Damage of Silicon Detectors
- 13. New Semiconductor Detector Concepts
- 14. Tracking Systems: ATLAS, CMS

6. Driftchamber



TDC: Time to Digital Converter

- Get external time reference t₀
 (scintillator)
- Measure arrival time of electrons at anode t₁

• x- coordinate given by
$$x = \int_{t_0}^{t_1} v_D(t) dt$$

• advantage of drift chamber: much larger sensitive volume per readout channel.

6. Driftchamber

drift cell

- Use graded potential to get uniform drift field.
- Gas amplification near anode wire.
- Position resolution (σ = 50 200 μ m)
 - v(t) distortions near wire
 - ionisation $\#udua(ib) \Delta t$
 - diffusion
 - electronic noise



CDF muon chambers



6. Driftchamber - Intrinsic Resolution



Particle Detectors 2

6. Driftchamber - Drift velocity



Some gas mixtures have a strong variation of drift velocity as function of E-field.

For stable operation it is useful to operate at maximum / plateau.

Typical drift velocities: 2-10 cm/ μ s = 20-100 ~m/ns.

6. Driftchamber in B-field



6. Planar Drift Chamber Types



6. CMS Muon Drift Tubes Chambers



Anode wire 50 μ m diameter gold-plated stainless steel wire.

Field electrode on top and bottom: 16 mm wide, 50 μ m thick aluminium tape.

+ 3600 V on wires, + 1800 V on strips, -1200 V on cathode.

Ar/CO2 gas mixture, e.g. 85%/15%

Gregor Herten / 6. Driftchamber



Aluminium tape

6. CMS Muon Drift Tube System



6. CMS Commissioning with Cosmics



Muon Barret Snith Tubres officiency



Muon Barren Month Thip Resolution



The hit resolution is computed from the residuals between the DT hits and the track segments in the muon spectrometer.

Typical values s ~ 200 − 260 µ/m

Good agreement with MC

Magnetic field degrades the resolution in the inner chamber in the external wheels.





14.ATLAS Muon System





14.ATLAS Cosmic Event



6. ATLAS MDT System Performance

Statistics/chamber in one long 2008 run



- 3 chambers not readout (gas system problems)
- 2 chambers with HV off
- 32 chambers with HV off for 1 of the 2 multilayers



6. ATLAS MDT Efficiency

HitsPerTubeAdcCut BML2A07



6. ATLAS MDT Expected Momentum Resolution

10% resolution at 1TeV dominated by position measurement resolution
Sagitta ~500μm

Position measurement ~50μm
 (obtained from 3 or 4 hits with 80-90μm resolution)

•Systematics must not spoil the overall accuracy

•Calibrations and alignment better than 30µm!

Alignment system: 12232 optical sensorsAutocalibration with dedicated data stream



6. ATLAS Muon Endcap Chamber Alignment





Layers of tracking detectors have to be aligned with respect to each other.

Precision in alignment should be comparable to sagitta error.

Inner Tracker: mainly use tracks.

Muon system: optical alignment and tracks.

Example: ATLAS endcap muon system

With CCD cameras (BCAM) the relative position of chambers is measured. The optical sensors are mounted on chambers and alignment bars, which serve as precise 3D calibration devices.

6. ATLAS Muon Endcap Chamber Alignment



Alignment bars are up to 10 m long. The 3D position of every platform is measured with a precision of 10 μ m. Since the position of every sensor (BCAM) on the bar is know the sensor reading is used to determine the position of chambers. The alignment error of chambers will be about 30 μ m. An optical system inside the bars measures the deformation of the bar.

14. ATLAS Muon MDT Chamber Cosmic Analysis

BARREL



Barrel Optical Alignment: at 200 μm level for large sectors (0.5-1mm for small ones)
Track based alignment : improvement to <50 μm level



6. Cylindrical Driftchambers



6. Cylindrical Driftchamber







- \approx 15000 wires
- total force from wire tension ≈ 6 tons

6. Readout of Second Coordinate



6.TPC - Time Projection Chamber



Time Projection Chamber full 3D track reconstruction: x-y from wires and segmented cathode of MWPC (or GEM) z from drift time

- momentum resolution space resolution + B field (multiple scattering)
- energy resolution measure of primary ionization

6.TPC - Time Projection Chamber

Developed by D. Nygren in the 70's.

Large gas volume with central electrode.

Drift distance of several meters.

Signal registered with MWPC, anode wires and cathode pads provide x,y ; drift time gives z.

Transverse diffusion reduced (electrons spiral around E-field, since E II B, Lamor radius < 1 μ m)

Very good 3D hit resolution and dE/dx.

Long drift times (\approx 40 μ s), thus rate limitations and very good gas quality required.



6. Gating in TPC

Problem:

- lons drift back to central electrode
- Disturbs homogeneity of electric field in drift region.

Solution:

- ions are collected on shielding grid
- only electrons from triggered events reach amplification region, others are collected at gating grid.
- external trigger required.



6. ALEPH TPC at LEP



6. ALEPH TPC at LEP

Aleph Higgs Candidate Event: $e^+e^- \rightarrow HZ \rightarrow bb + jj$



6. TPC for Heavy Ion Collisions

Au+ Au+ collision in the STAR Experiment/RHIC Up to 2000 tracks



Pb+ Pb+ Kollision in the ALICE Experiment/LHC Simulation for Angle Θ =60 to 62° Up to 40 000 tracks/collision



ALICE – A Large Ion Collider Experiment – at LHC



The ALICE Time Projection Chamber

in numbers



6.ALICE TPC



View inside the ALICE TPC

Simulated heavy ion collision in the ALICE TPC.



TPC performance

momentum resolution

Resolution determination

- cosmic muons reconstructed as two tracks
- use relative track information at vertex
- ~ 5x10⁶ events available



p_t resolution

measured:	6.5% at 10 GeV
	~1% below 1 GeV

design value: 4.5% at 10 GeV



7. Micropattern Gas Chamber (MPGC)



scale factor



Advantages of gas detectors:

- low radiation length
- large areas at low price
- flexible geometry
- spatial, energy resolution ...

Problem:

 rate capability limited by space charge defined by the time of evacuation of positive ions

Solution:

 reduction of the size of the detecting cell (limitation of the length of the ion path) using chemical etching techniques developed for microelectronics and keeping at same time similar field shape.

Gregor Herten / 7. Micropattern Gas Detectors

from L. Ropelewski

7. Microstrip Gas Chamber (MSGC)



Advantages:

- Very precise and small anode/cathode structures can be produced with lithographical methods. Thus very good position resolution is possible.
- MSGC provide high mechanical stability
- small drift distance for ions, thus high rate capability.

7. Micromegas - Micromesh Gaseous Structure



Micromesh mounted above readout structure (typically strips). E field similar to parallel plate detector. $E_a/E_i \sim 50$ to secure electron transparency and positive ion flowback supression.

MM01V1

Entries

Mean

hres

72994

0.0001025

Residuals



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7. TPC Readout with Micromega



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7. GEM - Gas Electron Multiplier





Electrons are collected on patterned readout board. A fast signal can be detected on the lower GEM electrode for triggering or energy discrimination. All readout electrodes are at ground potential. Positive ions partially collected on the GEM electrodes.

from L. Ropelewski

7. GEM - Gas Electron Multiplier



For a voltage between the GEM foils of 360 V the E-Field inside the gap reaches very high values, which cause gas amplification.

7. GEM - Characteristics

- Rate capability ~ 1 MHz mm^{-2}
- Position accuracy (MIPs) σ ~ 60 μm
- Radiation tolerance $> 100 \text{ mC mm}^{-2}$

ED

Ет

Εı

– corresponds to $\,\sim 10^{14}~\text{MIPs}~\text{cm}^{-2}$

DRIFT

GEM 1

GEM 2

READOUT



7. TPC Readout with GEM

• Narrow pad response function: $\Delta s \sim 1 \text{ mm}$ 0.006 Aachen/DESY • Fast signals (no ion tail): $\Delta t \sim 20$ ns 0.005 Effective Ion Feedback • Very good multi-track resolution: $\Delta V \sim 1 \text{ mm}^3$ 0.004 TELLING TELLINE ET - Standard MWPC TPC $\sim 1 \text{ cm}^3$ 0.003 • Ion feedback suppression: I+/I- ~ 0.1% t##### 0.002 0.001 (Design proposed for the TESLA TDR) 1.5 2 2.5 3 3.5 0.5 1 4.5 í٥ 4 B [T] transverse resolution a (mm) 10 20 20 20 10 20 20 10 10 20 10 20 1 DESY preliminary **0** T Т **GEM TPC** 500 600 0 100 200 300 400 from C. Niebuhr

5

Other (than tracking) Applications

Radiography with GEM (X-rays)



Trigger from the bottom electrode of GEM.



from L. Ropelewski

8. Limitations of Gaseous Detectors: Aging - Deposits



Complex plasma-chemical reactions in the avalanche can lead to polymerization.

Deposits on anode and cathode.

Deposits reduce electric field, which leads to reduced signal amplification (efficiency loss).

Malter effect:

Positive ions form a layer on cathode, high E-fields cause continuous electron extraction from cathode.

Leads to continuous discharge current.

9. Limitations of Gaseous Detectors : Deposits



Wiskers are produced on the anode wire. They absorb the electrons. Thus electrons do not reach the main amplification region very close to the wire. This leads to efficiency loss.

8. Discharges

(B.Schmidt NIMA515(2003))





Regions in the detector with large E-fields can lead to a sparks and to a break-down of the detector.

Insulators can charge up and produce high Efields. Adding water to the gas can increase the conductivity of the surfaces.

8. Discharges in GEM Detectors



Discharge probability for GEM detectors can be reduced with SGEM and TGEM (smaller voltage across each GEM foil).

8. Avoiding Aging

Material for construction:

- Use only material, which is certified in ageing test (high irradiation). Don't rely on manufacturers.
- Avoid glue, some type of plastic, PVC
- Be careful with O-rings (can contain silicone), printed circuit boards.
- Absolutely no silicone grease (often found in gas valves).

During construction:

- Absolute cleanliness
- No finger prints
- Clean all components before assembly, do not rely on cleaning by manufacturer.
- Perform aging tests with highly ionizing particles as early as possible, before mass production starts.

Operation:

- Use gas, which does not polymerize (noble gas, CO2, ..)
- Gas additives ca help (water, alcohol, ...)
- Avoid high currents (low gas gain)

Don't expect immortality:

B. Schmidt: "Detectors are like us: aging is unavoidable, surviving in good shape is the main issue.